GENERAL DESCRIPTION

The XR3160 is an advanced multiprotocol transceiver supporting RS-232, RS-485, and RS-422 serial standards. Full operation requires only four external charge pump capacitors.

The RS-485/$\overline{\text{RS-232}}$ pin selects RS-485 mode when high and RS-232 mode when low. The HALF/$\overline{\text{FULL}}$ pin configures the RS-485 modes as either half or full duplex.

The high speed drivers operate up to 20Mbps in RS-485/422 modes, and up to 1Mbps in RS-232 mode. All drivers can be slew limited to 250kbps in any mode to minimize electromagnetic interference (EMI) by setting the dedicated $\overline{\text{SLEW}}$ pin low.

All transmitter outputs and receiver inputs feature robust electrostatic discharge (ESD) protection to ±15kV IEC 61000-4-2 Airgap, ±15kV Human Body Model (HBM) and ±8kV IEC 61000-4-2 Contact. Each receiver output has full fail-safe protection to avoid system lockup, oscillation, or indeterminate states by defaulting to logic-high output level when the inputs are open, shorted, or terminated but undriven. No external biasing resistors are required.

The RS-232 receiver inputs include a 5kΩ pull-down to ground when in RS-232 mode. The RS-485/422 receiver inputs are high impedance (>96kΩ), allowing up to 256 devices on a single communication bus (1/8th unit load).

The XR3160 operates from a single power supply, 3V to 5.5V, with low idle current. The shutdown mode consumes less than 1µA in low power standby operation with RS-232 receivers enabled.

FEATURES

- **Pin Compatible Upgrade** for MAX3160 (20 SSOP)
- IEC Level 4 ESD Protection
  - **±15kV IEC 61000-4-2 Air Gap Discharge**
  - **± 8kV IEC 61000-4-2 Contact Discharge**
  - ±15kV Human Body Model (HBM)
- **20Mbps RS-485** and 1Mbps RS-232 Data Rates
- Pin-Selectable 250kbps Slew Limiting
- **Single Supply Operation from +3V to +5.5V**
- 2 Drivers, 2 Receivers RS-232/V.28
- 1 Driver, 1 Receiver RS-485/422
  - Full or Half Duplex Configuration
  - 1/8th Unit Load, up to 256 receivers on bus
- RS-485/422 Enhanced Receiver Fail-safe for open, shorted, or terminated but idle inputs
- **10nA Shutdown Supply Current** (typical)

TYPICAL APPLICATIONS

- Software Programmable Serial Ports (RS-232, RS-422, RS-485)
- Embedded and Industrial PCs (IPC)
- Process Control Equipment
- Point-Of-Sales Equipment
- Networking Equipment
- HVAC Controls Equipment
- Building Security and Automation

ORDERING INFORMATION

PART NUMBER	PACKAGE	OPERATING TEMPERATURE RANGE	DEVICE STATUS
XR3160EIU-F	20-pin SSOP	-40°C to +85°C	In Production
XR3160ECU-F	20-pin SSOP	0°C to +70°C	In Production

NOTE: *Tape and Reel part numbers are XR3160ExUTR-F, -F = Green / RoHS Compliant*

ABSOLUTE MAXIMUM RATINGS

These are stress ratings only and functional operation of the device at these ratings or any other above those indicated in the operation sections to the specifications below is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability and cause permanent damage to the device.

Supply Voltage V_{CC}	-0.3V to +6.0V
Voltage at TTL Input Pins	-0.3V to +6.0V
Receiver Input Voltage (from Ground)	±18V
Driver Output Voltage (from Ground)	±18V
Short Circuit Duration, TX out to Ground	Continuous
Storage Temperature Range	-65°C to +150°C
Lead Temperature (soldering, 10s)	+300°C
Power Dissipation 20-pin SSOP (derate 12.0mW/°C above +70°C)	662mW

CAUTION:

ESD (ElectroStatic Discharge) sensitive device. Permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. Personnel should be properly grounded prior to handling this device. The protective foam should be discharged to the destination socket before devices are removed.

ESD PROTECTION

		MIN.	TYP.	MAX.	UNITS	
	Tx Output & Rx Input Pins		±15		kV	IEC 61000-4-2 Airgap
			± 8		kV	IEC 61000-4-2 Contact
			±15		kV	Human Body Model (HBM)
	All Other Pins		± 3		kV	Human Body Model (HBM)

ELECTRICAL CHARACTERISTICS

UNLESS OTHERWISE NOTED:
V_{CC} = +3V to +5.5V, C1-C4 = 0.1µF; $T_A = T_{MIN}$ to T_{MAX}. Typical values are at V_{CC} = 3.3V, T_A = +25°C.

SYMBOL	PARAMETERS	MIN.	TYP.	MAX.	UNITS	CONDITIONS
DC CHARACTERISTICS						
I_{CC}	Supply Current (RS-232)		1.2	2.5	mA	No load, Idle inputs, RS-485/$\overline{\text{RS-232}}$ = 0V
I_{CC}	Supply Current (RS-485/422)		2.5	5.5	mA	No load, Idle inputs, RS-485/$\overline{\text{RS-232}}$ = V_{CC}
I_{CC}	V_{CC} Shutdown Current		0.01	1	µA	$\overline{\text{SHDN}}$ = 0V, Receiver inputs open or grounded
TRANSMITTER and LOGIC INPUT PINS (DI, T1IN, T2IN, DE, $\overline{\text{SHDN}}$, $\overline{\text{SLEW}}$, HALF/$\overline{\text{FULL}}$, RS-485/$\overline{\text{RS-232}}$)						
V_{IL}	Logic Input Voltage Low			0.8	V	
V_{IH}	Logic Input Voltage High	2.0			V	V_{CC} = +3.3V
V_{IH}	Logic Input Voltage High	2.4			V	V_{CC} = +5.0V
I_{INL}	Logic Input Leakage Current		±0.01	±1	µA	
V_{HYS}	Logic Input Hysteresis		0.2		V	
RS-232 and RS-485/422 RECEIVER OUTPUTS (R1OUT, R2OUT, RO)						
V_{OL}	Receiver Output Voltage Low			0.4	V	I_{OUT} = 2.5mA
V_{OH}	Receiver Output Voltage High	V_{CC}-0.6			V	I_{OUT} = -1.5mA
I_{OSS}	Receiver Output Short Circuit Current		±20	±85	mA	$0 \le V_O \le V_{CC}$
I_{OZ}	Receiver Output Leakage Current		±0.05	±1	µA	$0 \le V_O \le V_{CC}$, Receivers disabled

ELECTRICAL CHARACTERISTICS (Continued)

UNLESS OTHERWISE NOTED:
V_{CC} = +3V to +5.5V, C1-C4 = 0.1µF; $T_A = T_{MIN}$ to T_{MAX}. Typical values are at V_{CC} = 3.3V, T_A = +25°C.

SYMBOL	PARAMETERS	MIN.	TYP.	MAX.	UNITS	CONDITIONS
RS-232 SINGLE-ENDED RECEIVER INPUTS (R1IN, R2IN)						
V_{IN}	Input Voltage Range	-15		+15	V	
V_{IL}	Input Threshold Low	0.6	1.2		V	V_{CC} = +3.3V
		0.8	1.5		V	V_{CC} = +5.0V
V_{IH}	Input Threshold High		1.5	2.0	V	V_{CC} = +3.3V
			1.8	2.4	V	V_{CC} = +5.0V
V_{HYS}	Input Hysteresis		0.5		V	
R_{IN}	Input Resistance	3	5	7	kΩ	V_{CC} = +3.0V to 5.5V
RS-232 SINGLE-ENDED TRANSMITTER OUTPUTS (T1OUT, T2OUT)						
V_{OUT}	Output Voltage Swing	±5.0	±5.4		V	Outputs loaded with 3kΩ to Gnd
R_{OFF}	Output Power Off Impedance	300	10M		Ω	V_{CC} = 0V, V_{OUT} = ±2V
I_{SC}	Output Short Circuit Current		±30	±60	mA	V_{OUT} = 0V
I_O	Output Leakage Current			±125	µA	$\overline{SHDN}$ = 0V, V_{OUT} = ±9V, V_{CC} = 0V or 5.5V

ELECTRICAL CHARACTERISTICS (Continued)

UNLESS OTHERWISE NOTED:
V_{CC} = +3V to +5.5V, C1-C4 = 0.1µF; $T_A = T_{MIN}$ to T_{MAX}. Typical values are at V_{CC} = 3.3V, T_A = +25°C.

SYMBOL	PARAMETERS	MIN.	TYP.	MAX.	UNITS	CONDITIONS
RS-485/422 DIFFERENTIAL RECEIVER INPUTS (A,B)						
R_{IN}	Receiver Input Resistance	96			kΩ	-7V ≤ V_{CM} ≤ +12V
I_{IN}	Receiver Input Current			125	µA	V_{IN} = +12V
				-100	µA	V_{IN} = -7V
V_{TH}	Receiver Differential Threshold Voltage	-200	-125	-50	mV	-7V ≤ V_{CM} ≤ +12V
ΔV_{TH}	Receiver Input Hysteresis		30		mV	
RS-485/422 DIFFERENTIAL DRIVER OUTPUTS (Y, Z)						
V_{OD}	Differential Driver Output	1.5		V_{CC}	V	R_L = 54Ω (RS-485), Figure 4
		1.5		V_{CC}	V	-7V ≤ V_{CM} ≤ +12V, Figure 5
		2		V_{CC}	V	R_L = 100Ω (RS-422), Figure 4
$\lvert\Delta V_{OD}\rvert$	Change In Magnitude of Differential Output Voltage			0.2	V	R_L = 54Ω or 100Ω, Figure 4
V_{CM}	Driver Common Mode Output Voltage			3	V	R_L = 54Ω or 100Ω, Figure 4
$\lvert\Delta V_{CM}\rvert$	Change In Magnitude of Common Mode Output Voltage			0.2	V	R_L = 54Ω or 100Ω, Figure 4
I_{OSD}	Driver Output Short Circuit Current			±250	mA	-7V ≤ V_Y or V_Z ≤ +12V, Figure 6
I_O	Driver Output Leakage Current			±125	µA	DE = 0V or $\overline{SHDN}$ = 0V, V_Y or V_Z = -7V or +12V, V_{CC} = 0V or 5.25V

TIMING CHARACTERISTICS

UNLESS OTHERWISE NOTED:
V_{CC} = +3V to +5.5V, C1-C4 = 0.1µF; $T_A = T_{MIN}$ to T_{MAX}. Typical values are at V_{CC} = 3.3V, T_A = +25°C

SYMBOL	PARAMETERS	MIN.	TYP.	MAX.	UNITS	CONDITIONS
ALL MODES						
t_{ENABLE}	Enable from Shutdown		1000		ns	
$t_{SHUTDOWN}$	Enable to Shutdown		1000		ns	
RS-232, DATA RATE = 250kbps ($\overline{SLEW}$ = 0V), ONE TRANSMITTER SWITCHING						
	Maximum Data Rate	250			kbps	R_L = 3kΩ, C_L = 1000pF
t_{RHL}, t_{RLH}	Receiver Propagation Delay		100		ns	C_L = 150pF, Figure 7
$\lvert t_{RHL}-t_{RLH}\rvert$	Receiver Propagation Delay Skew			100	ns	
t_{DHL}, t_{DLH}	Driver Propagation Delay		1400		ns	R_L = 3kΩ, C_L = 2500pF, Figure 8
$\lvert t_{DHL}-t_{DLH}\rvert$	Driver Propagation Delay Skew			600	ns	
t_{SHL}, t_{SLH}	Transition Region Slew Rate from +3.0V to -3.0V or -3.0V to +3.0V	6		30	V/µs	V_{CC} = +3.3V, R_L = 3kΩ to 7kΩ, C_L = 150pF to 2500pF, T_A = 25°C, Figure 8
t_{SHL}, t_{SLH}	Transition Region Slew Rate from +3.0V to -3.0V or -3.0V to +3.0V	4		30	V/µs	V_{CC} = +3.3V, R_L = 3kΩ to 7kΩ, C_L = 150pF to 2500pF, Figure 8
RS-232, DATA RATE = 1Mbps ($\overline{SLEW}$ = V_{CC}), ONE TRANSMITTER SWITCHING						
	Maximum Data Rate	1			Mbps	R_L = 3kΩ, C_L = 250pF
t_{RHL}, t_{RLH}	Receiver Propagation Delay		100		ns	C_L = 150pF, Figure 7
$\lvert t_{RHL}-t_{RLH}\rvert$	Receiver Propagation Delay Skew			100	ns	
t_{DHL}, t_{DLH}	Driver Propagation Delay		300		ns	R_L = 3kΩ, C_L = 1000pF, Figure 8
$\lvert t_{DHL}-t_{DLH}\rvert$	Driver Propagation Delay Skew			150	ns	
t_{SHL}, t_{SLH}	Transition Region Slew Rate from +3.0V to -3.0V or -3.0V to +3.0V	13		150	V/µs	V_{CC} = +3.3V, R_L = 3kΩ to 7kΩ, C_L = 150pF to 1000pF, Figure 8
t_{SHL}, t_{SLH}	Transition Region Slew Rate from +3.0V to -3.0V or -3.0V to +3.0V	24		150	V/µs	V_{CC} = +3.3V, R_L = 3kΩ to 7kΩ, C_L = 150pF to 1000pF, T_A = 25°C, Figure 8

TIMING CHARACTERISTICS (Continued)

UNLESS OTHERWISE NOTED:
V_{CC} = +3V to +5.5V, C1-C4 = 0.1µF; $T_A = T_{MIN}$ to T_{MAX}. Typical values are at V_{CC} = 3.3V, T_A = +25°C.

SYMBOL	PARAMETERS	MIN.	TYP.	MAX.	UNITS	CONDITIONS
RS-485/RS-422, DATA RATE = 250kbps ($\overline{SLEW}$ = 0V), ONE TRANSMITTER SWITCHING						
	Maximum Data Rate	250			kbps	R_L = 54Ω, C_L = 50pF
t_{RPHL}, t_{RPLH}	Receiver Propagation Delay		50	150	ns	C_L = 15pF, Figure 9
$\lvert t_{RPHL}-t_{RPLH}\rvert$	Receiver Propagation Delay Skew			10	ns	
t_{DPHL}, t_{DPLH}	Driver Propagation Delay		500	1000	ns	R_L = 54Ω, C_L = 50pF, Figure 10
$\lvert t_{DPHL}-t_{DPLH}\rvert$	Driver Propagation Delay Skew			100	ns	
t_{DR}, t_{DF}	Driver Rise and Fall Time	300	650	1200	ns	
t_{DZH}, t_{DZL}	Driver Output Enable Time			1000	ns	R_L = 500Ω, C_L = 50pF, Figure 11
t_{DHZ}, t_{DLZ}	Driver Output Disable Time			200	ns	
RS-485/RS-422, DATA RATE = 20Mbps ($\overline{SLEW}$ = V_{CC}), ONE TRANSMITTER SWITCHING						
	Maximum Data Rate	20			Mbps	R_L = 54Ω, C_L = 50pF
t_{RPHL}, t_{RPLH}	Receiver Propagation Delay		50	150	ns	C_L = 15pF, Figure 9
$\lvert t_{RPHL}-t_{RPLH}\rvert$	Receiver Propagation Delay Skew			10	ns	
t_{DPHL}, t_{DPLH}	Driver Propagation Delay		30	100	ns	R_L = 54Ω, C_L = 50pF, Figure 10
$\lvert t_{DPHL}-t_{DPLH}\rvert$	Driver Propagation Delay Skew			10	ns	
t_{DR}, t_{DF}	Driver Rise and Fall Time		10	20	ns	
t_{DZH}, t_{DZL}	Driver Output Enable Time			200	ns	R_L = 500Ω, C_L = 50pF, Figure 11
t_{DHZ}, t_{DLZ}	Driver Output Disable Time			200	ns	

PIN DESCRIPTIONS

Pin	Name	RS-232	RS-485 Full Duplex	RS-485 Half Duplex
1	C1+	Charge pump cap 1 positive lead, 0.1µF		
2	VCC	Main Supply, V_{CC} = +3.0V to +5.5V, bypass to ground with 1.0µF		
3	C1-	Charge pump cap 1 negative lead		
4	GND	Ground		
5	T1OUT, B/Z	Transmitter 1 Output	Z Driver Neg Output	B/Z Neg Input/Output
6	T2OUT, A/Y	Transmitter 2 Output	Y Driver Pos Output	A/Y Pos Input/Output
7	R1OUT	Receiver 1 Output	X	X
8	R2OUT, RO	Receiver 2 Output	Receiver TTL Output	Receiver TTL Output
9	$\overline{\text{SHDN}}$	Low power shutdown mode when low		
10	$\overline{\text{SLEW}}$	Data rate limited to 250kbps when low		
11	RS-485/$\overline{\text{RS-232}}$	0	1	1
12	HALF/$\overline{\text{FULL}}$	X	0	1
13	R2IN, A	Receiver 2 Input	A Pos Receiver Input	X
14	R1IN, B	Receiver 1 Input	B Neg Receiver Input	X
15	T2IN, DE	Transmitter 2 Input	Driver enabled when high	
16	T1IN, DI	Transmitter 1 Input	Driver TTL Input	
17	V-	Charge pump negative supply, 0.1µF from ground		
18	C2-	Charge pump cap 2 negative lead		
19	C2+	Charge pump cap 2 positive lead, 0.1µF		
20	V+	Charge pump positive supply, 0.1µF to ground		

SUGGESTED DB9 CONNECTOR PINOUT

DB9 Pin	RS-232	RS-485 Full Duplex	RS-485 Half Duplex
1			
2	RXD	RX+	
3	TXD	TX-	Data-
4			
5	Ground		
6			
7	RTS	TX+	Data+
8	CTS	RX-	
9			

BLOCK DIAGRAMS

FIGURE 1. RS-232 MODE

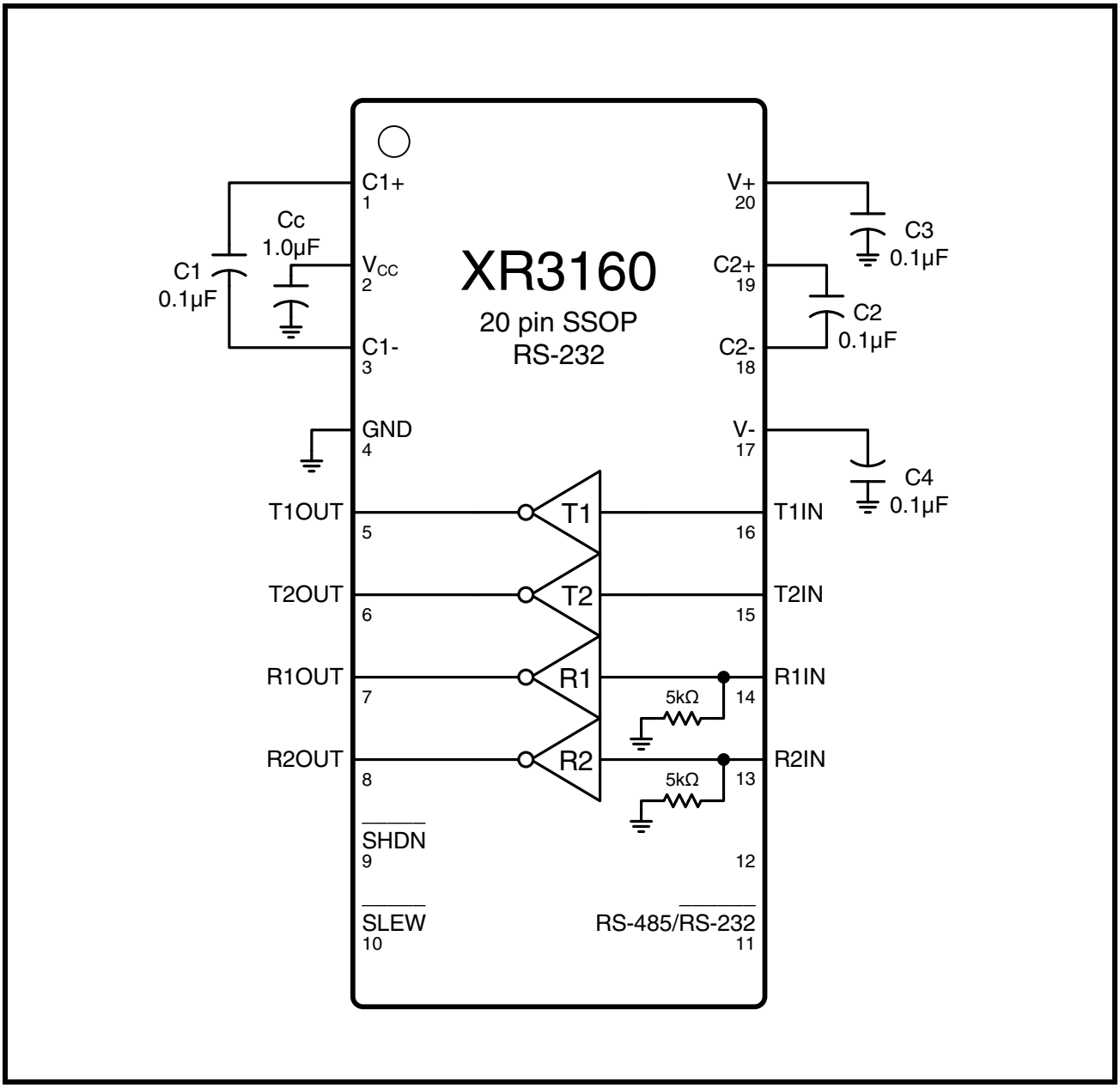


FIGURE 2. RS-485/422 FULL DUPLEX MODE

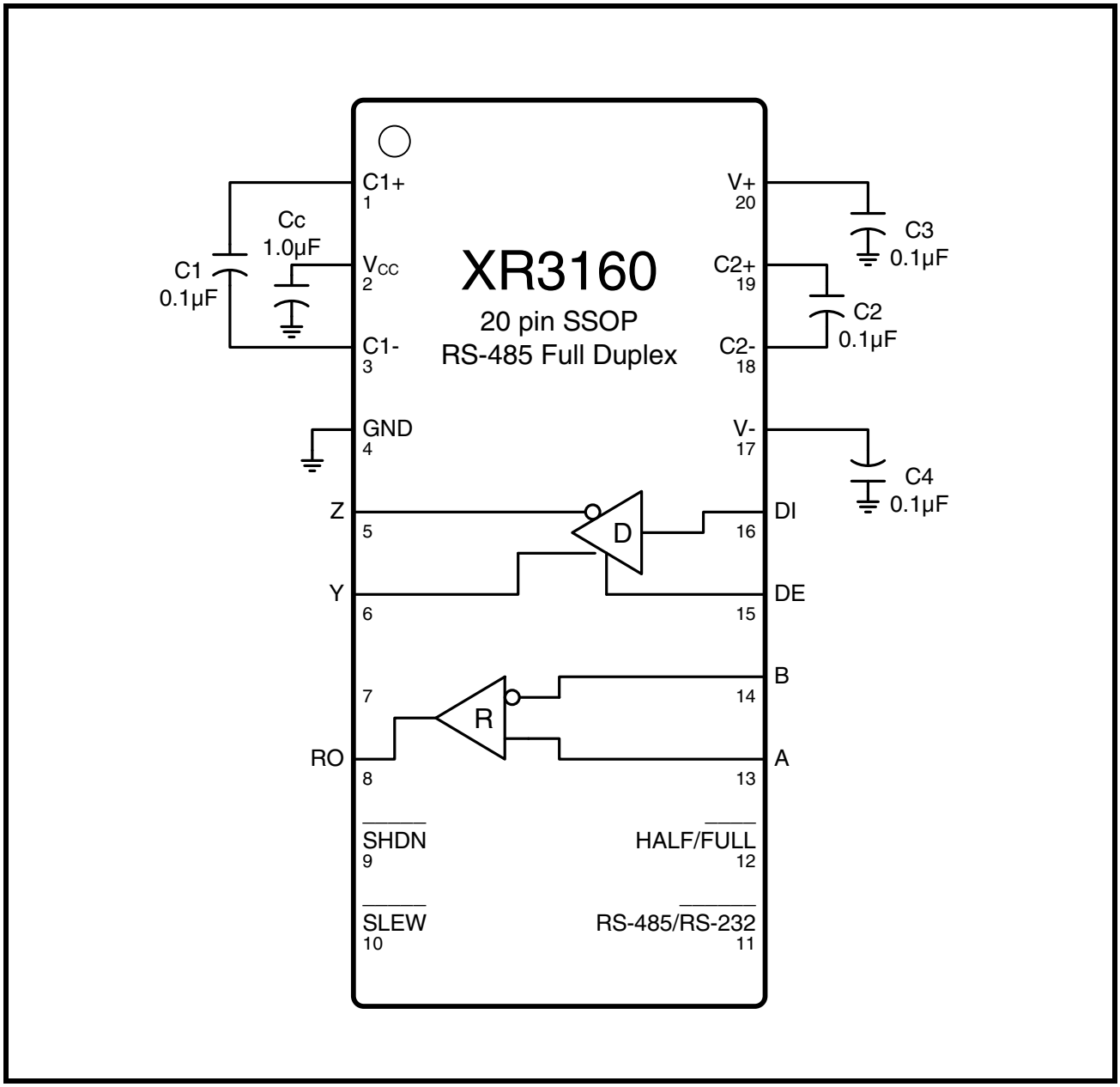
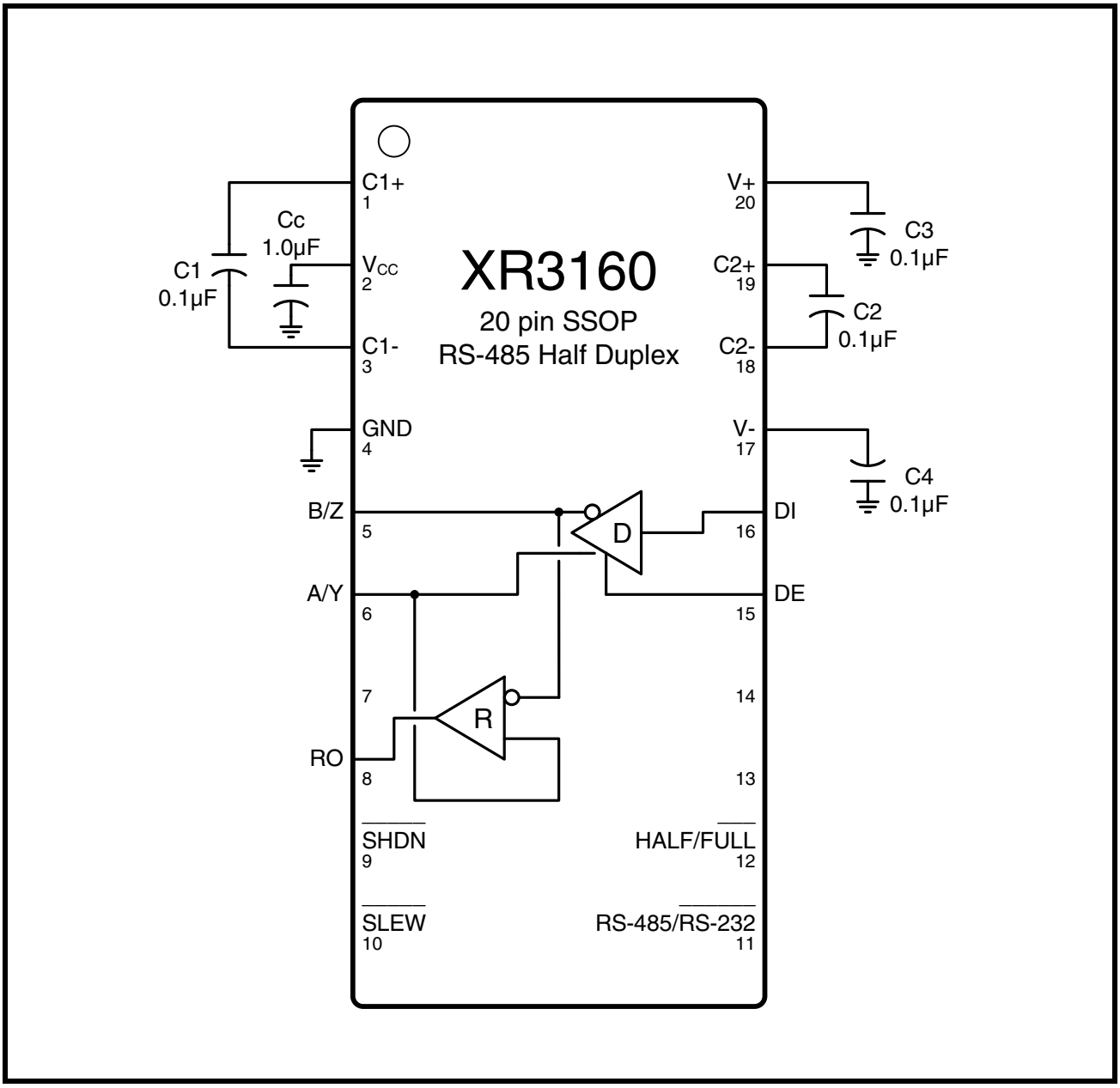


FIGURE 3. RS-485 HALF DUPLEX MODE



TEST CIRCUITS

FIGURE 4. RS-485/422 DIFFERENTIAL DRIVER OUTPUT VOLTAGE

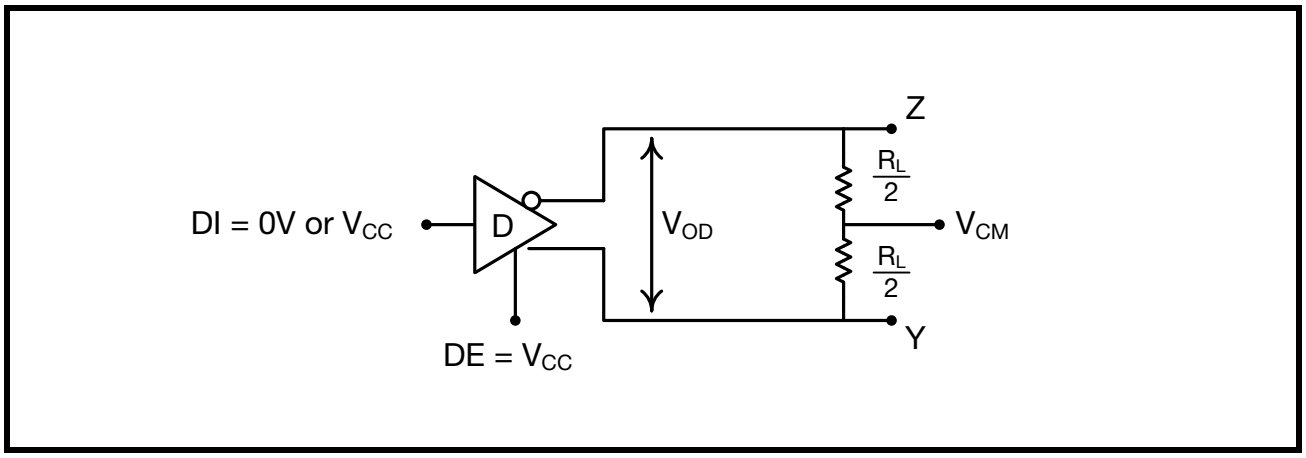


FIGURE 5. RS-485/422 DIFFERENTIAL DRIVER OUTPUT VOLTAGE OVER COMMON MODE

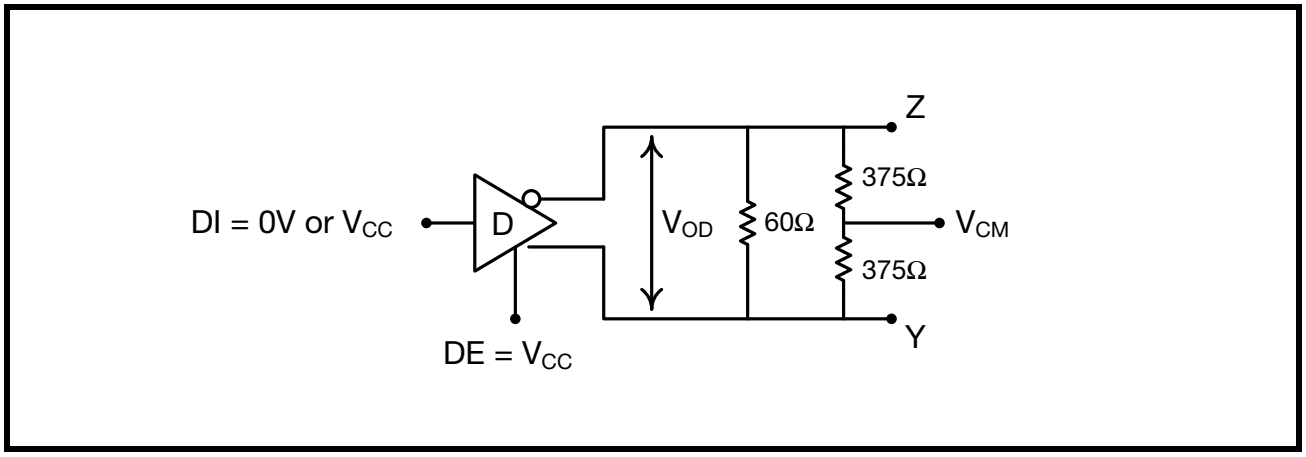


FIGURE 6. RS-485/422 DRIVER OUTPUT SHORT CIRCUIT CURRENT

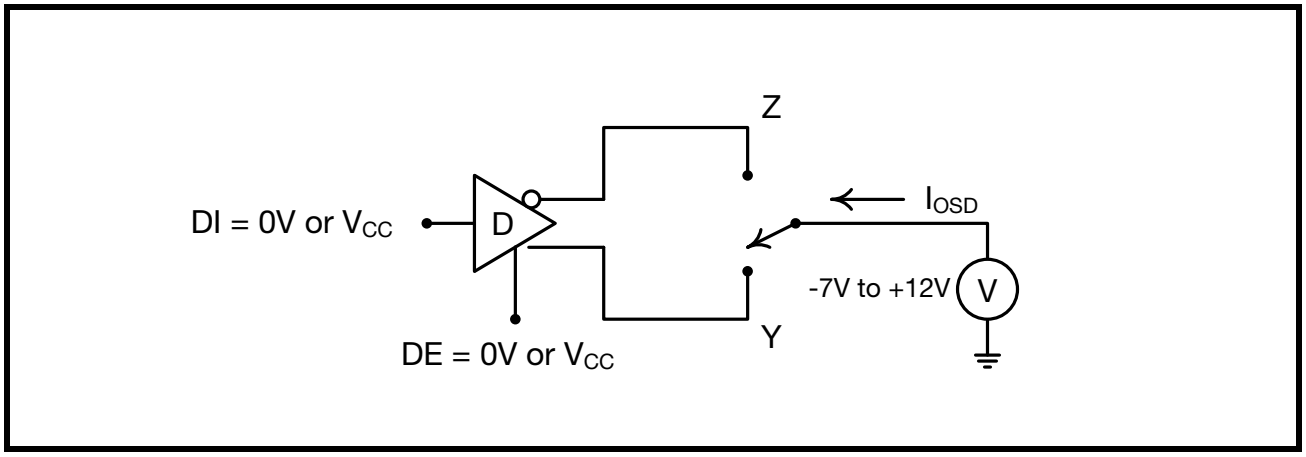


FIGURE 7. RS-232 RECEIVER PROPAGATION DELAY

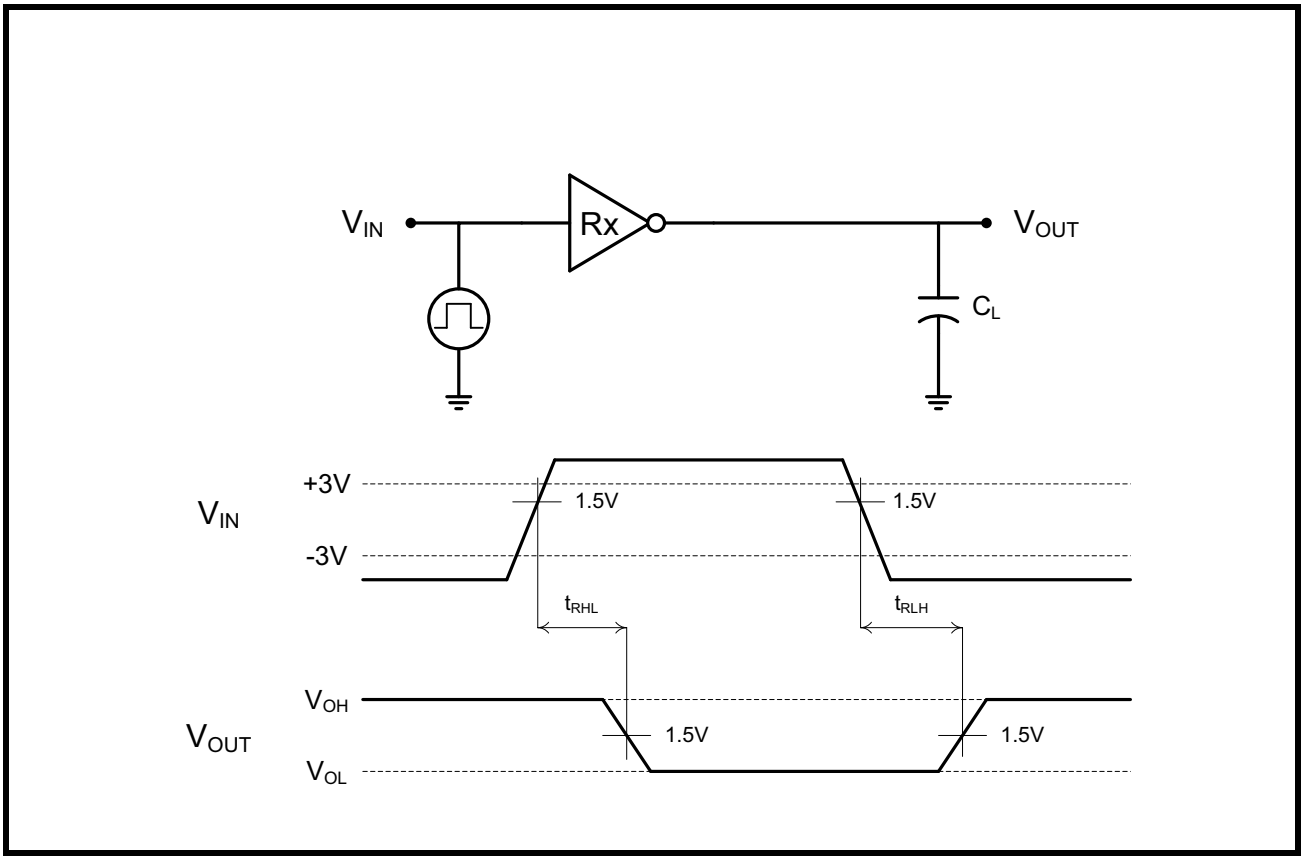


FIGURE 8. RS-232 DRIVER PROPAGATION DELAY

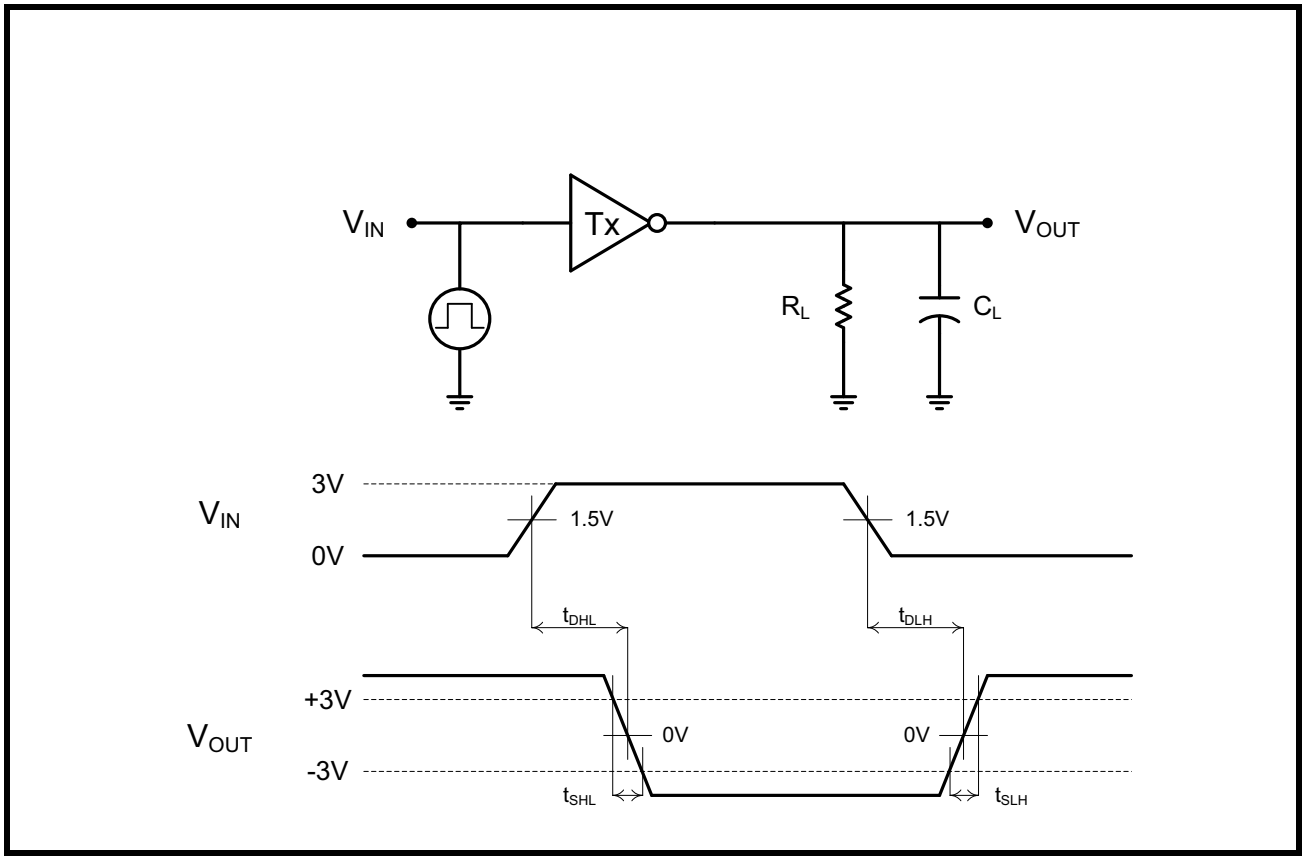
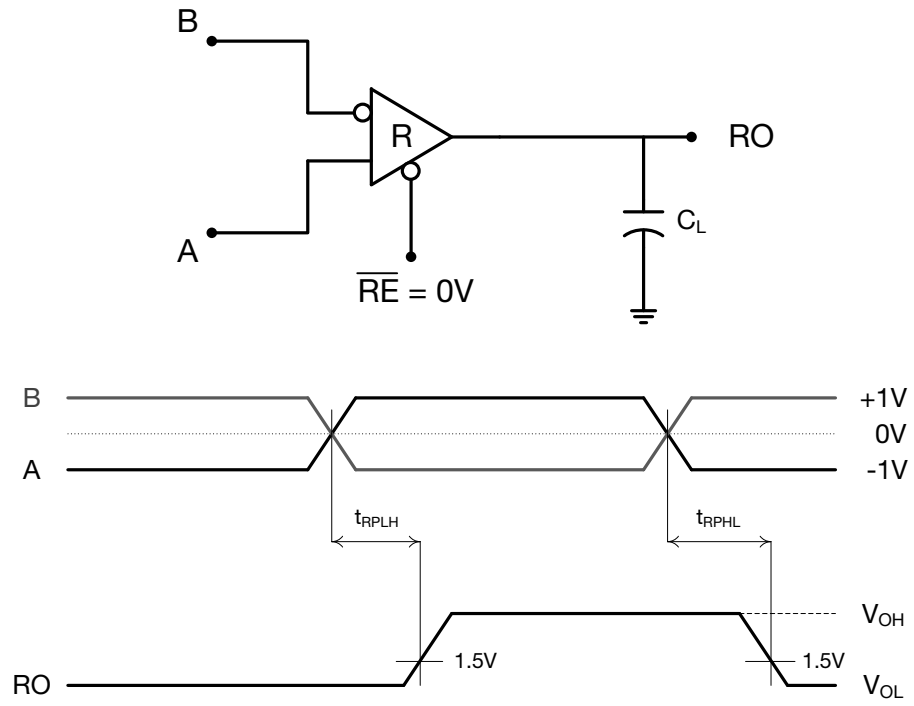


FIGURE 9. RS-485/422 RECEIVER PROPAGATION DELAY



The $\overline{RE}$ control is internally fixed to 0V in the RS-485/422 modes (receiver always on).

FIGURE 10. RS-485/422 DRIVER PROPAGATION DELAY AND RISE/FALL TIMES

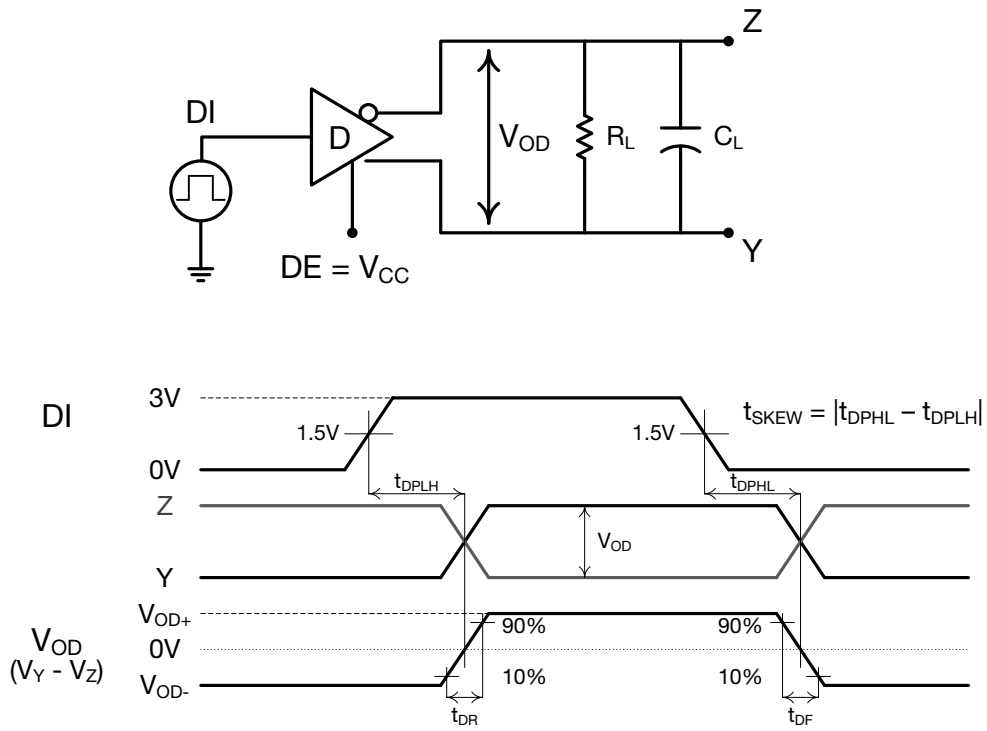
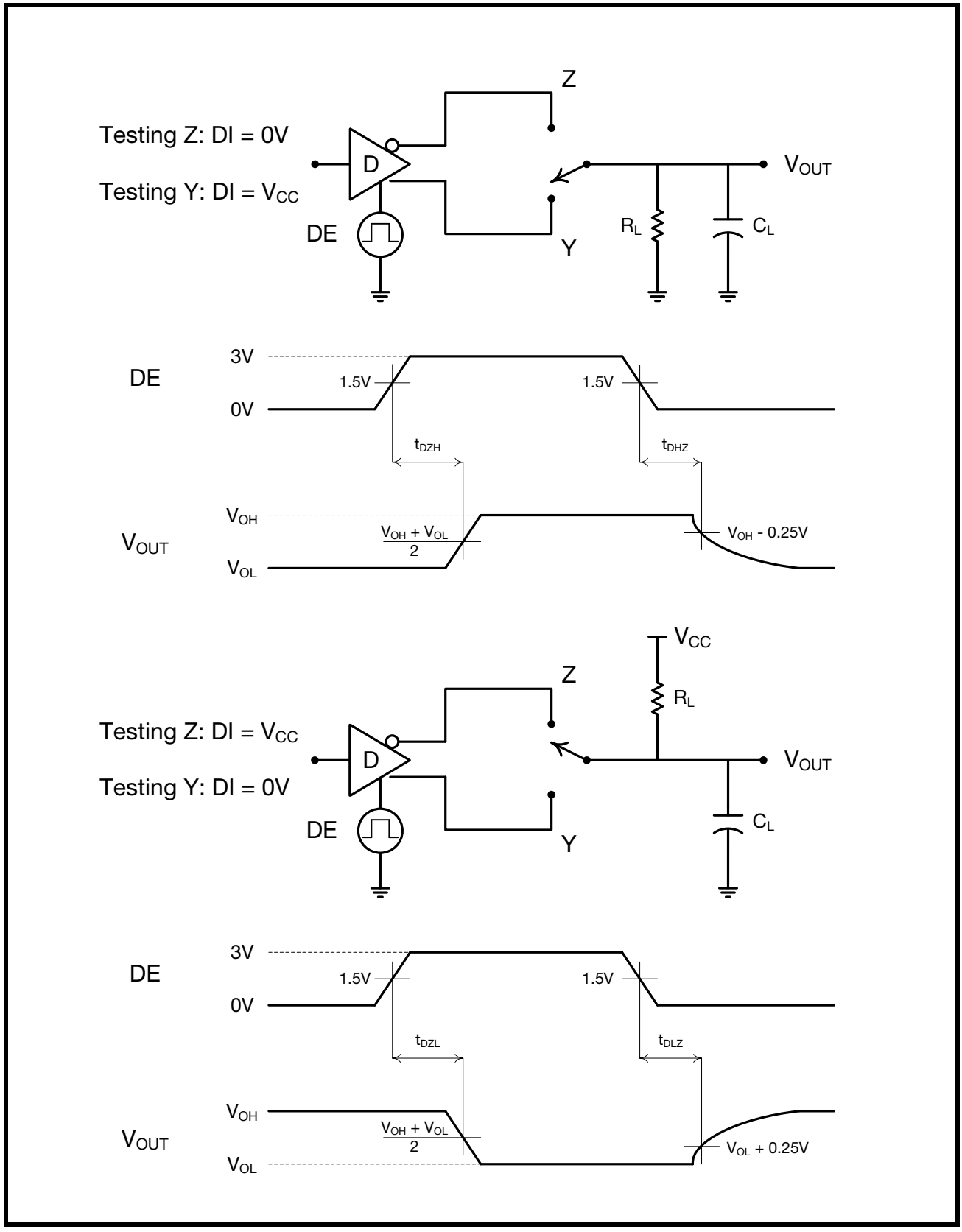


FIGURE 11. RS-485/422 DRIVER OUTPUT ENABLE/DISABLE TIMES



PRODUCT SUMMARY

The XR3160 is an advanced multiprotocol transceiver supporting RS-232, RS-485, and RS-422 serial standards. Full operation requires only four external charge pump capacitors.

ENHANCED FAILSAFE

The enhanced failsafe feature of the XR3160 guarantees a logic-high receiver output when the receiver inputs are open, shorted, or terminated but idle/undriven. The enhanced failsafe interprets 0V differential as a logic high with a minimum 50mV noise margin, while maintaining compliance with the EIA/TIA-485 standard of ±200mV. No external biasing resistors are required, further easing the usage of multiple protocols over a single connector.

±15kV ESD PROTECTION

ESD protection structures are incorporated on all pins to protect against electrostatic discharges encountered during handling and assembly. The bus pins (driver outputs and receiver inputs) have extra protection structures, which have been tested up to ±15kV without damage. These structures withstand high ESD in all states: normal operation, in shutdown, and when powered off.

ESD protection is be tested in various ways. Exar uses the following methods to qualify the protection structures designed into XR3160:

±8kV using IEC 61000-4-2 Contact Discharge

±15kV using IEC 61000-4-2 Airgap Discharge

±15kV using the Human Body Model (HBM)

The IEC 61000-4-2 standard is more rigorous than HBM, resulting in lower voltage levels compared with HBM for the same level of ESD protection. Because IEC 61000-4-2 specifies a lower series resistance, the peak current is higher than HBM. The XR3160 has passed both HBM and IEC 61000-4-2 testing without damage.

TRUTH TABLES

TABLE 1: RS-232 TX TRUTH TABLE

INPUTS			OUTPUTS
$\overline{SHDN}$	RS-485/$\overline{RS-232}$	DI/T1IN, DE/T2IN	Z(B)/T1OUT, Y(A)/T2OUT
0	X	X	1/8th unit load
1	0	0	1
1	0	1	0
1	1	X	RS-485 Mode

TABLE 2: RS-232 RX TRUTH TABLE

INPUTS			OUTPUTS
$\overline{SHDN}$	RS-485/$\overline{RS-232}$	B/R1IN, A/R2IN	R1OUT, RO/R2OUT
X	0	0	1
X	0	1	0
X	0	Inputs open	1
X	1	X	R1OUT High-Z, RO/R2OUT in RS-485 Mode

TABLE 3: RS-485/422 TX TRUTH TABLE

INPUTS				OUTPUTS	
$\overline{\text{SHDN}}$	RS-485/$\overline{\text{RS-232}}$	DE/T2IN	DI/T1IN	Z(B)/T1OUT	Y(A)/T2OUT
0	X	X	X	1/8th unit load	1/8th unit load
1	1	0	X	1/8th unit load	1/8th unit load
1	1	1	0	1	0
1	1	1	1	0	1
X	0	X	X	RS-232 Mode	

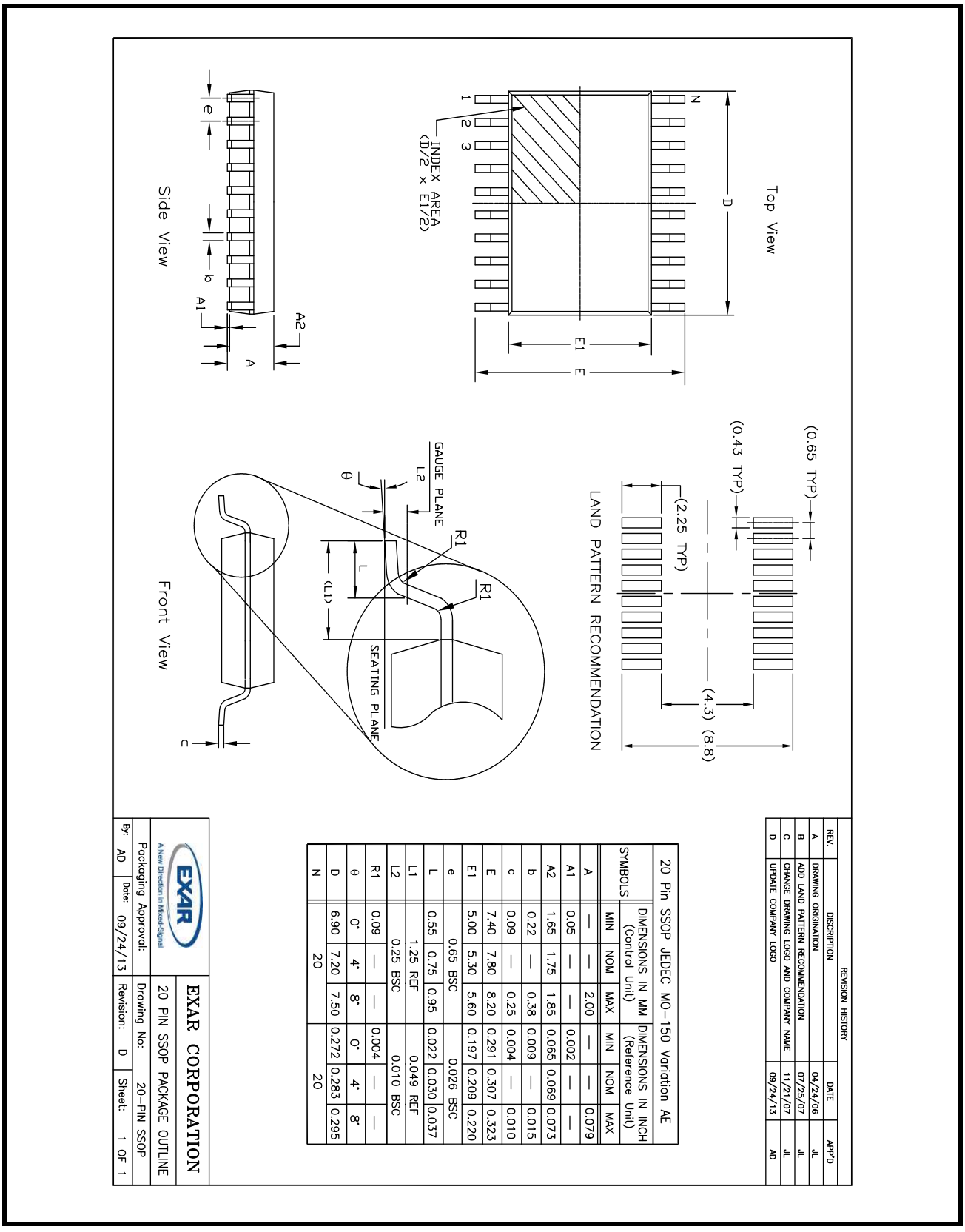
TABLE 4: RS-485/422 RX TRUTH TABLE

INPUTS					OUTPUT
RS-485/$\overline{\text{RS-232}}$	$\overline{\text{SHDN}}$	HALF/$\overline{\text{FULL}}$	(A-B)	(Y-Z)	RO/R2OUT
1	0	X	X	X	High-Z
1	1	0	≥ -50mV	X	1
1	1	0	≤ -200mV	X	0
1	1	0	Floating	X	1
1	1	1	X	≥ -50mV	1
1	1	1	X	≤ -200mV	0
1	1	1	X	Floating	1
0	X	X	X	X	RS-232 Mode

* Y and Z correspond to pins 6 and 5. A and B correspond to pins 13 and 14.

PACKAGE DRAWINGS

FIGURE 12. SSOP 20



REVISION HISTORY

REV.	DISCRIPTION	DATE	APP'D
A	DRAWING ORIGINATION	04/24/06	JL
B	ADD LAND PATTERN RECOMMENDATION	07/25/07	JL
C	CHANGE DRAWING LOGO AND COMPANY NAME	11/21/07	JL
D	UPDATE COMPANY LOGO	09/24/13	AD

20 Pin SSOP JEDEC MO-150 Variation AE

SYMBOLS	DIMENSIONS IN MM (Control Unit)			DIMENSIONS IN INCH (Reference Unit)		
	MIN	NOM	MAX	MIN	NOM	MAX
A	—	—	2.00	—	—	0.079
A1	0.05	—	—	0.002	—	—
A2	1.65	1.75	1.85	0.065	0.069	0.073
b	0.22	—	0.38	0.009	—	0.015
c	0.09	—	0.25	0.004	—	0.010
E	7.40	7.80	8.20	0.291	0.307	0.323
E1	5.00	5.30	5.60	0.197	0.209	0.220
e	0.65 BSC			0.026 BSC		
L	0.55	0.75	0.95	0.022	0.030	0.037
L1	1.25 REF			0.049 REF		
L2	0.25 BSC			0.010 BSC		
R1	0.09	—	—	0.004	—	—
θ	0°	4°	8°	0°	4°	8°
D	6.90	7.20	7.50	0.272	0.283	0.295
N	20			20		

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20 PIN SSOP PACKAGE OUTLINE

Packaging Approval:		Drawing No:	20-PIN SSOP
By: AD	Date: 09/24/13	Revision: D	Sheet: 1 OF 1

REVISION HISTORY

DATE	REVISION	DESCRIPTION
Sept 2013	1.0.0	Production Release

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